TOSHIBA PHOTOCOUPLER GaAs IRED & PHOTO-TRIAC

TLP3020,TLP3021,TLP3022,TLP3023

OFFICE MACHINE HOUSEHOLD USE EQUIPMENT TRIAC DRIVER SOLID STATE RELAY

The TOSHIBA TLP3020, TLP3021, TLP3022 and TLP3023 consist of a photo-triac optically coupled to a gallium arsenide infrared emitting diode in a six lead plastic DIP package.

Peak Off-State Voltage : 400 V (Min.)

Trigger LED Current : 30mA (Max.) (TLP3020)

> 15 mA (Max.) (TLP3021) 10 mA (Max.) (TLP3022) 5 mA (Max.) (TLP3023)

On-State Current : 100 mA (Max.)

UL Recognized : UL1577, File No. E67349

Isolation Voltage : 5000 Vrms (Min.)

Option (D4) Type

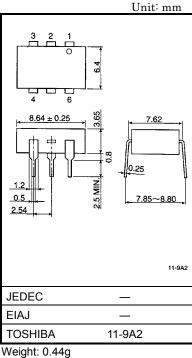
VDE Approved : DIN VDE0884 / 08.87, Certificate No. 68329

Maximum Operating Insulation Voltage: 630 VPK Highest Permissible Over Voltage: 6000 VPK

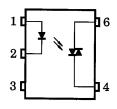
Note: When a VDE0884 approved type is needed, please designate

the "Option (D4)"

			7.62mm pich	10.16 mm pich
			standard type	(LF2) type
•	Creepage Distance	: -	7.0 mm (Min.)	8.0 mm (Min.)
	Clearance	:	7.0 mm (Min.)	8.0 mm (Min.)
	Insulation Thickness	:	0.5 mm (Min.)	0.5 mm (Min.)



PIN CONFIGURATION (TOP VIEW)



ANODE CATHODE 3: N.C. 4: TERMINAL 1 6: TERMINAL 2



MAXIMUM RATINGS (Ta=25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT	
	Forward Current		I _F	50	mA
	Forward Current Derating (Ta ≥ 53°C)		ΔI _F /°C	-0.7	mA/°C
	Peak Forward Current (100μs pulse, 100pps)		I _{FP}	1	А
LED	Power Dissipation		P _D	100	mW
	Power Dissipation Derating (Ta ≥ 25°C)		ΔP _D /°C	-1.0	mW/°C
	Reverse Voltage		V _R	5	V
	Junction Temperature		Tj	125	°C
	Off-State Output Terminal Voltage		V_{DRM}	400	V
	On-Stage RMS	Ta=25°C	lever co.	100	mA
	Current	Ta=70°C	I _{T(RMS)}	50	IIIA
<u>«</u>	On-State Current Derating (Ta ≥ 25°C)		Δl _T /°C	-1.1	mA/°C
DETECTOR	Peak On-Stage Current (100 µs pulse, 120pps)		I _{TP}	2	А
DET	Peak Nonrepetitive Surge Current (P _W =10ms, DC=10%)		I _{TSM}	1.2	А
	Power Dissipation		P _D	300	mW
	Power Dissipation Derating (Ta ≥ 25°C)		∆P _D /°C	-4.0	mW/°C
	Junction Temperature		Tj	115	°C
Storag	ge Temperature Rar	nge	T _{stg}	− 55 ~ 150	°C
Operating Temperature Range			T _{opr}	− 40 ~ 100	°C
Lead Soldering Temperature (10s)			T _{sol}	260	°C
Total Package Power Dissipation			P _T	330	mW
Total Package Power Dissipation Derating (Ta ≥ 25°C)			ΔP _T /°C	-4.4	mW/°C
Isolation Voltage (AC, 1 min., R.H. ≤ 60%) (Note 1)			BV _S	5000	Vrms

Note 1: Device considered a two terminal device :Pins 1, 2 and 3 shorted together and pins 4 and 6 shorted together.

RECOMMENDED OPERATING CONDISTIONS

CHARACTERISTICS	SYMBOL	MIN	TYP.	MAX	UNIT
Supply Voltage	V_{AC}	_	_	120	Vac
Forward Current	I _F *	15	20	25	mA
Peak On-Stage Current	I _{TP}	_	_	1	Α
Operating Temperature	T _{opr}	-25	_	85	°C

^{*:} In the case of TLP3022



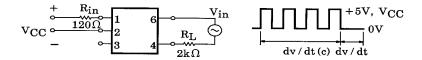
INDIVIDUAL ELECTRICAL CHARACTERISTICS (Ta=25°C)

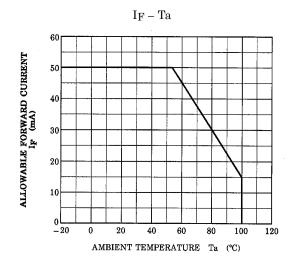
	CHARACTERISTIC	SYMBOL TEST CONDITION MIN TYP.		TYP.	MAX	UNIT	
	Forward Voltage	V _F	I _F =10mA	1.0	1.15	1.3	V
LED	Reverse Current	I _R	V _R =5V	_	_	10	μА
	Capacitance	C _T	V=0, f=1MHz	_	10	_	pF
	Peak Off-State Current	I _{DRM}	V _{DRM} =400V	_	10	100	nA
DETECTOR	Peak On-Stage Voltage	V _{TM}	I _{TM} =100mA	_	1.7	3.0	V
	Holding Current	lΗ	_	_	0.6	_	mA
	Critical Rate of Rise of Off- State Voltage	dv / dt	V _{in} =120Vrms, Ta=85°C (Fig.1)	200	500		V/μs
	Critical Rate of Rise of Commutating Voltage	dv / dt(c)	V _{in} =30Vrms, IF=15mA (Fig.1)		0.2		V/μs

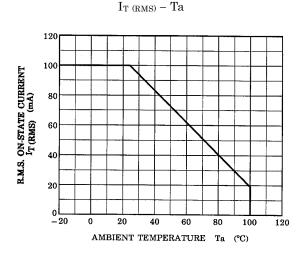
COUPLED ELECTRICAL CHARACTERISTICS (Ta=25°C)

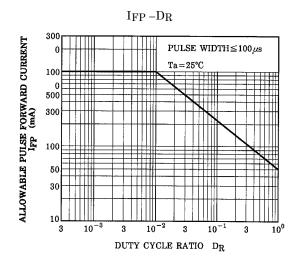
CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT	
	TLP3020	l I _{FT}	V _T =3V	_	_	30	- mA	
Trigger LED Current	TLP3021			_	_	15		
riiggei LLD Cuireiii	TLP3022			_	5	10		
	TLP3023			_	_	5		
Capacitance Input to Output		C _S	V _S =0, f=1MHz	_	0.8	_	pF	
Isolation Resistance		R _S	V _S =500V (R.H. ≤ 60%)	5×10 ¹⁰	10 ¹⁴		Ω	
Isolation Voltage		B _{VS}	AC, 1 minute				V _{rms}	
			AC, 1 second (in oil)	_	10000		٧.	
			DC, 1 minute (in oil)	_	10000		V _{dc}	

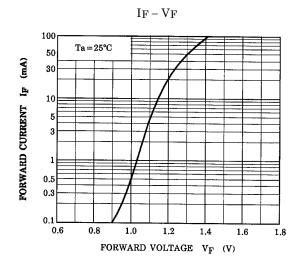
Fig. 1 dv/dt TEST CIRCUIT

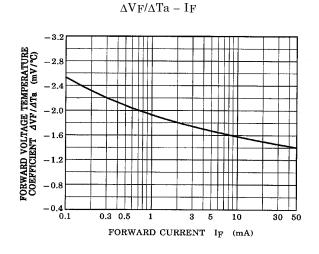


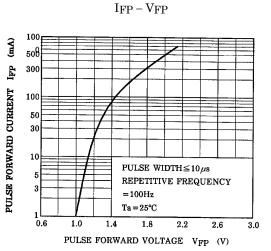




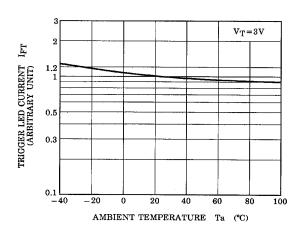




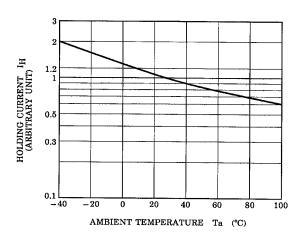




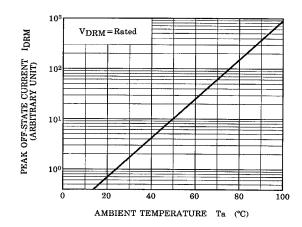
NORMALIZED IFT - Ta



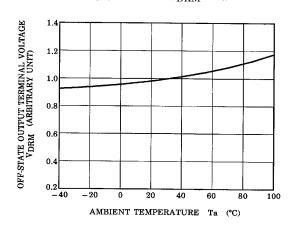
$NORMALIZED\ I_H - Ta$



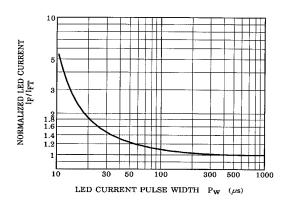
 $NORMALIZED\ IDRM-Ta$



NORMALIZED V_{DRM} – Ta



NORMALIZED LED CURRENT – LED CURRENT PULSE WIDTH



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000707EBC

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